

Mid-Power LED - 5630 Series

SAW7Q24D (Cool, Neutral, Warm)



Product Brief

Description

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- This White Colored surface-mount LED comes in standard package dimension. Package Size: 5.6x3.0x0.65mm
- It has a substrate made up of a molded plastic reflector sitting on top of a lead frame.
- The die is attached within the reflector cavity and the cavity is encapsulated by silicone.
- The package design coupled with careful selection of component materials allow these products to perform with high reliability.

Features and Benefits

- Market Standard 5630 Package Size
- High Color Quality, CRI Min. 70
- ANSI & MacAdam 3 Step compliant
- RoHS compliant

Key Applications

- Interior lighting
- General lighting
- Indoor and outdoor displays
- Architectural / Decorative lighting

Table 1. Product Selection Table

Part Number		ССТ		
Part Number	Color	Min.	Тур.	Max.
SAW7Q24D	Cool White	4,700K	5,600K	7,000K
SAW7Q24D	Neutral White	3,700K	4,200K	4,700K
SAW7Q24D	Warm White	2,600K	3,000K	3,700K









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SAW7Q24D – Mid-Power LED

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Performance Characteristics

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_	CCT (K) ^[1]		Luminous	Intensity ^[2]	Luminou	IS Flux ^[3]	CRI
Part Number		RANK	I _v (cd)	Φν	(Im)	R _a
	Тур.		Min	Max	Min	Max	Min.
	6500	T5	10.5	11.0	33.5	35.0	70
	0500	U0	11.0	11.7	35.0	37.3	70
	5600	T5	10.5	11.0	33.5	35.0	70
	5000	U0	11.0	11.7	35.0	37.3	70
	5000	UO	11.0	11.7	35.0	37.3	70
	5000	U7	11.7	12.5	37.3	39.8	70
	4500	UO	11.0	11.7	34.7	36.9	70
SAW7Q24D	4500	U7	11.7	12.5	36.9	39.4	70
SAW/Q24D	4000	UO	11.0	11.7	34.7	36.9	70
	4000	U7	11.7	12.5	36.9	39.4	70
	3500	T5	10.5	11.0	32.8	34.4	70
	3500	U0	11.0	11.7	34.4	36.6	70
	3000	T5	10.5	11.0	32.8	34.4	70
	3000	U0	11.0	11.7	34.4	36.6	70
	2700	T5	10.5	11.0	32.8	34.4	70
	2700	U0	11.0	11.7	34.4	36.6	70

Table 2. Electro Optical Characteristics, I_F =32mA, T_i=25°C, RH30%

Notes :

- (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- (2) Seoul Semiconductor maintains a tolerance of ±7% on Intensity and power measurements. The luminous intensity IV was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.
- (3) The lumen table is only for reference.
- (4) Solid angle 0.01sr (reference)

Performance Characteristics

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Table 3. Characteristics, I_F =32mA, T_i = 25°C, RH30%

Parameter	Cumhal		Value		Unit
Farameter	Symbol	Min.	Тур.	Max.	Unit
Forward Current	I _F	-	32	100	mA
Luminous Intensity ^[1] (5,000K) ^[2]	Ιv	-	11.6	-	cd
CRI ^[3]	R _a	70	73	80	
Viewing Angle	20 _{1/2}	-	120	-	Deg.
Thermal resistance (J to S) ^[4]	Rθ _{J-S}	-	7	-	°C/W
ESD Sensitivity(HBM)	-		Class 3A JES	D22-A114-E	

Table 4. Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I _F	100	mA
Froward Voltage	V _F	6.0	V
Power Dissipation	P _D	0.6	W
Junction Temperature	Τ _j	125	°C
Operating Temperature	T _{opr}	-40 ~ + 85	٥C
Storage Temperature	T _{stg}	-40 ~ + 100	°C

Notes :

- (1) Seoul Semiconductor maintains a tolerance of \pm 7% on Intensity and power measurements.
- (2) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.

Color coordinate : $\pm 0.005,$ CCT $\pm 5\%$ tolerance.

- (3) Tolerance is ± 2.0 on CRI measurements.
- (4) Thermal resistance is junction to Solder.
- (5) I_{FP} conditions with pulse width ≤10ms and duty cycle ≤10%
- Calculated performance values are for reference only.
- All measurements were made under the standardized environment of Seoul Semiconductor.



Characteristics Graph

Fig 1. Color Spectrum, $T_j = 25^{\circ}C$, $I_F = 32mA$

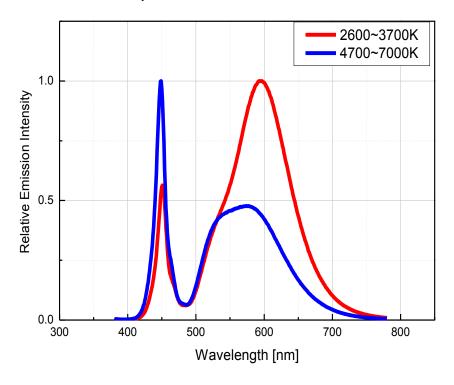
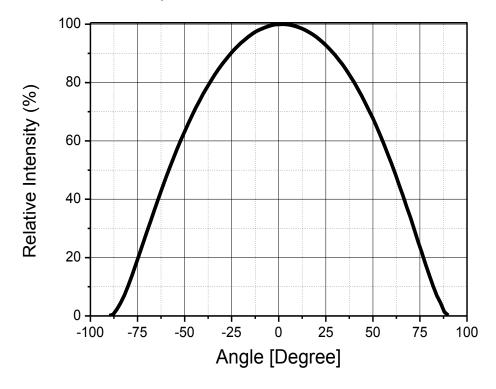


Fig 2. Radiant Pattern, T_j = 25°C, I_F=32mA





Characteristics Graph

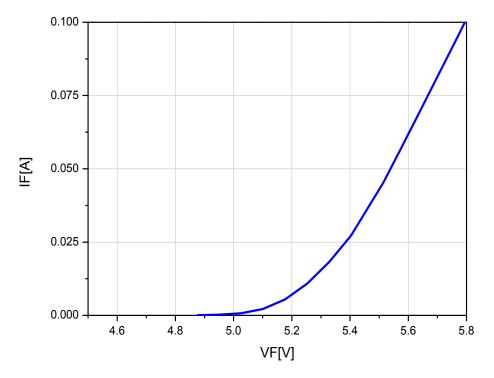
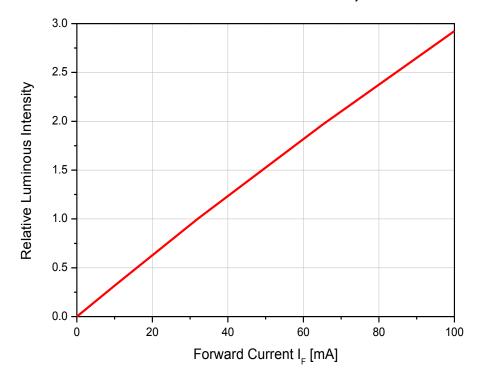


Fig 3. Forward Voltage vs. Forward Current, $T_j = 25^{\circ}C$

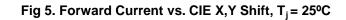
Fig 4. Forward Current vs. Relative Luminous Intensity, T_j = 25°C

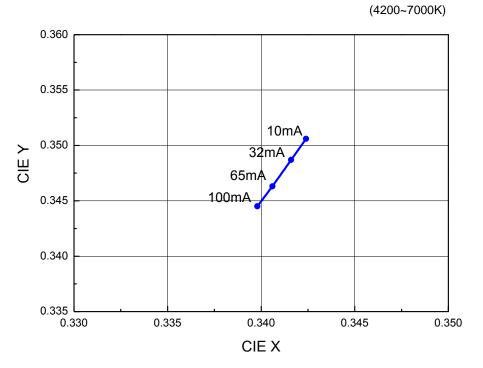


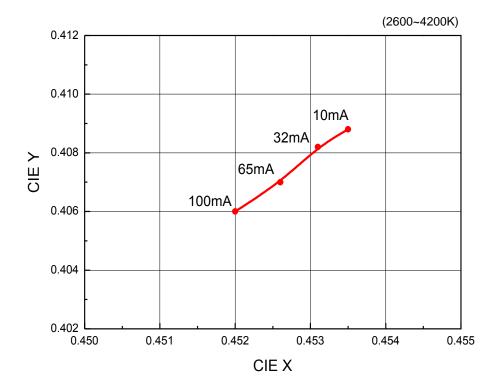


Characteristics Graph

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Characteristics Graph

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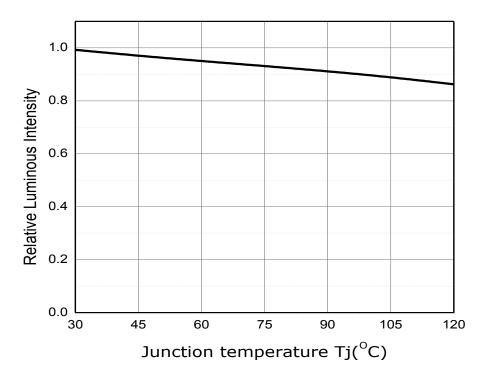
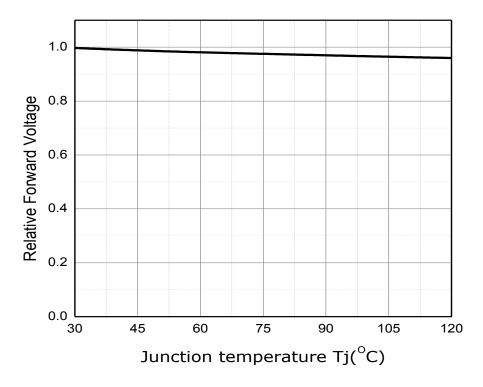


Fig 6. Junction Temperature vs. Relative Luminous Intensity, $I_F=32mA$

Fig 7. Junction Temperature vs. Relative Forward Voltage, $I_F=32mA$



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Characteristics Graph

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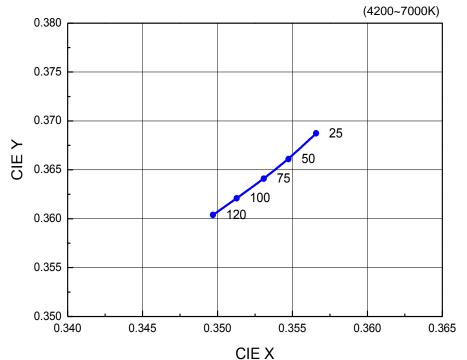
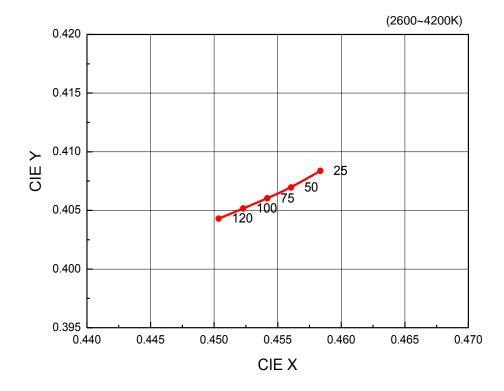
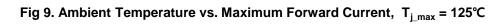


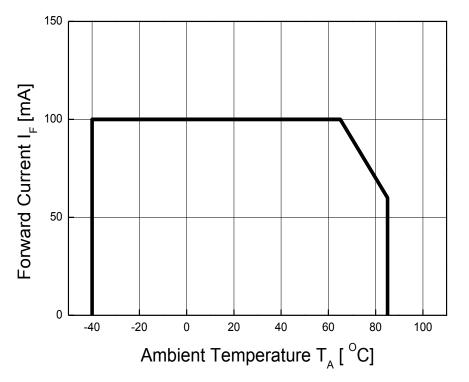
Fig 8. Chromaticity Coordinate vs. Junction Temperature, I_F=32mA





Characteristics Graph





Available ranks



SAW7Q24D – Mid-Power LED

Performance Characteristics

Table 5. Bin Code description, T_i=25°C, I_F=32mA

Part Number	Lum	inous Inter (cd)	nsity	Color Chromaticity	Туріса	l Forward V (V)	'oltage
Fait Nulliber	Bin Code	Min.	Max.	Coordinate	Bin Code	Min.	Max.
	T5	10.5	11.0		Z52	5.2	5.4
SAW7Q24D	UO	11.0	11.7	Refer to Page. 12	Z54	5.4	5.6
	U7	11.7	12.5		Z56	5.6	5.8

Table 6. Intensity rank distribution

сст	CIE		IV Rank	
6000 ~ 7000K	A	T5	UO	U7
5300 – 6000K	В	T5	UO	U7
4700 ~ 5300K	C	T5	UO	U7
4700 ~ 3300K 4200 ~ 4700K	D	T5	UO	U7
4200 ~ 4700K 3700 ~ 4200K	E	T5	UO	U7
	_	-		
3200 ~ 3700K	F	T5	UO	U7
2900 ~ 3200K	G	T5	UO	U7
2600 ~ 2900K	Н	T5	UO	U7

*Notes :

(1) Calculated performance values are for reference only.

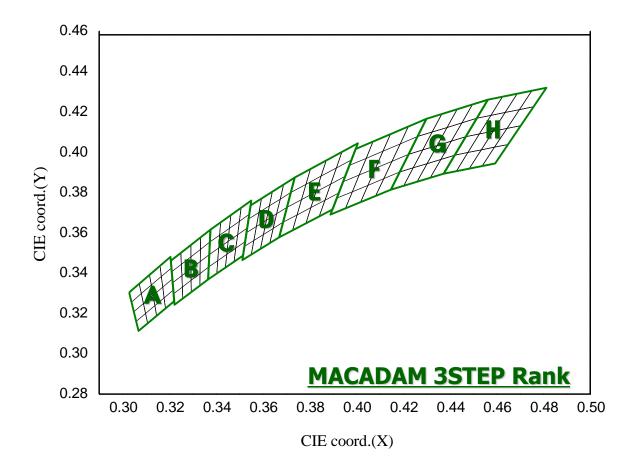
All measurements were made under the standardized environment of Seoul Semiconductor.
 In order to ensure availability, single color rank will not be orderable.



Color Bin Structure

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CIE Chromaticity Diagram T_i=25°C, I_F=32mA



*Notes :

• Energy Star binning applied to all 2600~7000K.

- Measurement Uncertainty of the Color Coordinates : $\pm \ 0.005$

Color Bin Structure

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6000K 0.35 A41 6500K 0.34 A31 A42 7000K A21 A32 A43 ≻ _{0.33} CIE A11 A22 A33 A44 A12 A23 A34 A13 0.32 A24 A14 0.31 0.300 0.305 0.310 0.315 0.320 0.325 CIE X

A	11	A	21	A3	31	A	11
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3028	0.3304	0.3072	0.3349	0.3115	0.3393	0.3160	0.3437
0.3038	0.3256	0.3080	0.3299	0.3123	0.3342	0.3166	0.3384
0.3080	0.3299	0.3123	0.3342	0.3166	0.3384	0.3209	0.3426
0.3072	0.3349	0.3115	0.3393	0.3160	0.3437	0.3205	0.3481
A	12	A	22	A3	2	A	12
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3038	0.3256	0.3080	0.3299	0.3123	0.3342	0.3166	0.3384
0.3048	0.3209	0.3089	0.3249	0.3131	0.3290	0.3172	0.3331
0.3089	0.3249	0.3131	0.3290	0.3172	0.3331	0.3213	0.3371
0.3080	0.3299	0.3123	0.3342	0.3166	0.3384	0.3209	0.3426
A	13	A	23	A3	3	A	43
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3048	0.3209	0.3089	0.3249	0.3131	0.3290	0.3172	0.3331
0.3058	0.3161	0.3098	0.3200	0.3138	0.3239	0.3178	0.3277
0.3098	0.3200	0.3138	0.3239	0.3178	0.3277	0.3217	0.3316
0.3089	0 00 40	0.04.04	0 0000	0.0470	0.0004	0.3213	0.3371
	0.3249	0.3131	0.3290	0.3172	0.3331	0.5215	
A		0.3131 A		0.3172 A3		0.0210 A4	14
A ² CIE X		1				-	I4 CIE Y
-	14	A	24	A3	4	A	
CIE X	I4 CIE Y	A: CIE X	24 CIE Y	A3 CIE X	4 CIE Y	A4 CIE X	CIE Y
CIE X 0.3058	14 CIE Y 0.3161	CIE X 0.3098	24 CIE Y 0.3200	A3 CIE X 0.3138	CIE Y 0.3239	CIE X 0.3178	CIE Y 0.3277

CIE Chromaticity Diagram (Cool white), T_i=25°C, I_F=32mA

Color Bin Structure

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5300K 0.36 5600K B41 **B31** 0.35 6000K B42 B21 B32 B11 ≻ ∃ 0.34 B43 **B22** B33 **B12** B44 **B23** B34 B13 **B24** 0.33 B14 0.32 0.320 0.325 0.330 0.335 0.340 CIE X

B41 **B11 B21 B**31 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.3207 0.3462 0.3250 0.3501 0.3292 0.3539 0.3334 0.3578 0.3518 0.3211 0.3407 0.3252 0.3444 0.3293 0.3481 0.3333 0.3252 0.3444 0.3293 0.3481 0.3333 0.3518 0.3374 0.3554 0.3250 0.3501 0.3292 0.3539 0.3334 0.3578 0.3376 0.3616 B12 **B22 B**32 B42 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.3407 0.3252 0.3444 0.3481 0.3518 0.3211 0.3293 0.3333 0.3215 0.3353 0.3254 0.3388 0.3293 0.3423 0.3332 0.3458 0.3254 0.3388 0.3293 0.3423 0.3332 0.3458 0.3371 0.3493 0.3252 0.3444 0.3293 0.3481 0.3333 0.3518 0.3374 0.3554 B13 B23 B33 B43 CIE X CIE Y CIE X CIE X CIE Y CIE X CIE Y CIE Y 0.3254 0.3423 0.3332 0.3215 0.3353 0.3388 0.3293 0.3458 0.3218 0.3298 0.3256 0.3331 0.3294 0.3364 0.3331 0.3398 0.3256 0.3331 0.3294 0.3364 0.3331 0.3398 0.3369 0.3431 0.3254 0.3388 0.3293 0.3423 0.3332 0.3458 0.3371 0.3493 B14 B24 **B**34 B44 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.3218 0.3298 0.3256 0.3331 0.3294 0.3364 0.3331 0.3398 0.3222 0.3243 0.3258 0.3275 0.3294 0.3306 0.3330 0.3338 0.3258 0.3275 0.3294 0.3306 0.3330 0.3338 0.3366 0.3369 0.3256 0.3331 0.3294 0.3364 0.3331 0.3398 0.3369 0.3431

CIE Chromaticity Diagram (Cool white), $T_j=25^{\circ}C$, $I_F=32mA$



Color Bin Structure

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0.38 4700K 5000K C41 0.37 C31 5300K C42 C21 ≻ ^{0.36} ≝ C11 C32 C22 C43 C12 C33 C23 C44 0.35 C13 C34 C24 C14 0.34 0.340 0.345 0.355 0.335 0.350 CIE X

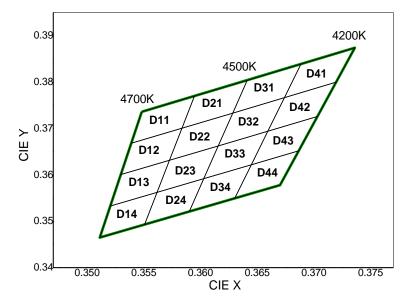
C	11	C:	21	Ca	31	C	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3376	0.3616	0.3420	0.3652	0.3463	0.3687	0.3507	0.3724
0.3374	0.3554	0.3415	0.3588	0.3457	0.3622	0.3500	0.3657
0.3415	0.3588	0.3457	0.3622	0.3500	0.3657	0.3542	0.3692
0.3420	0.3652	0.3463	0.3687	0.3507	0.3724	0.3551	0.3760
C	12	C	22	Ca	32	C	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3374	0.3554	0.3415	0.3588	0.3457	0.3622	0.3500	0.3657
0.3371	0.3493	0.3411	0.3525	0.3452	0.3558	0.3492	0.3591
0.3411	0.3525	0.3452	0.3558	0.3492	0.3591	0.3533	0.3624
0.3415	0.3588	0.3457	0.3622	0.3500	0.3657	0.3542	0.3692
C	13	C	23	Ca	3	C	43
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3371	0.3493	0.3411	0.3525	0.3452	0.3558	0.3492	0.3591
0.3369	0.3431	0.3407	0.3462	0.3446	0.3493	0.3485	0.3524
0.3407	0.3462	0.3446	0.3493	0.3485	0.3524	0.3523	0.3555
0.3411	0.3525	0.3452	0.2550	0.0400	0.0504	0.3533	0.3624
	0.3525	0.3452	0.3558	0.3492	0.3591	0.5555	
	14		24	0.3492 C3		0.0000 C4	
C	14	C	24	Ca	34	C4	14
C CIE X	14 CIE Y	CIE X	24 CIE Y	Cie X	4 CIE Y	C4 CIE X	14 CIE Y
CIE X 0.3369	14 CIE Y 0.3431	CIE X 0.3407	24 CIE Y 0.3462	CIE X 0.3446	CIE Y 0.3493	C4 CIE X 0.3485	14 CIE Y 0.3524

CIE Chromaticity Diagram (Cool white), $T_j=25^{\circ}C$, $I_F=32mA$



Color Bin Structure

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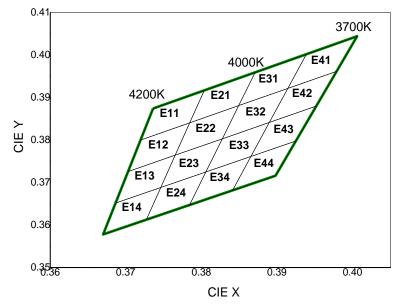
CIE Chromaticity Diagram (Neutral white), $T_i=25^{\circ}C$, $I_F=32mA$

D1	11	D	21	D	31	D4	\$ 1
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3548	0.3736	0.3595	0.3770	0.3641	0.3804	0.3689	0.3839
0.3539	0.3668	0.3584	0.3701	0.3628	0.3733	0.3674	0.3767
0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	0.3720	0.3800
0.3595	0.3770	0.3641	0.3804	0.3689	0.3839	0.3736	0.3874
D	12	D	22	D	32	D4	12
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3539	0.3668	0.3584	0.3701	0.3628	0.3733	0.3674	0.3767
0.3530	0.3601	0.3573	0.3632	0.3616	0.3663	0.3659	0.3694
0.3573	0.3632	0.3616	0.3663	0.3659	0.3694	0.3703	0.3726
0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	0.3720	0.3800
0.000.	0.0701	0.0020	0.0700	0.0074	0.0101	0.5720	0.0000
D1			23	D:		0.3720 D4	
D1	13	D	23	D	3	D4	13
D1 CIE X	I3 CIE Y	D: CIE X	23 CIE Y	D: CIE X	CIE Y	D4 CIE X	43 CIE Y
D ⁴ CIE X 0.3530	13 CIE Y 0.3601	CIE X 0.3573	23 CIE Y 0.3632	D3 CIE X 0.3616	CIE Y 0.3663	D4 CIE X 0.3659	43 CIE Y 0.3694
D1 CIE X 0.3530 0.3520	CIE Y 0.3601 0.3533	CIE X 0.3573 0.3562	23 CIE Y 0.3632 0.3562	CIE X 0.3616 0.3603	CIE Y 0.3663 0.3592	CIE X 0.3659 0.3645	43 CIE Y 0.3694 0.3622
D' CIE X 0.3530 0.3520 0.3562	I3 CIE Y 0.3601 0.3533 0.3562 0.3632	CIE X 0.3573 0.3562 0.3603 0.3616	23 CIE Y 0.3632 0.3562 0.3592	CIE X 0.3616 0.3603 0.3645	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687	43 CIE Y 0.3694 0.3622 0.3652 0.3726
CIE X 0.3530 0.3520 0.3562 0.3573	I3 CIE Y 0.3601 0.3533 0.3562 0.3632	CIE X 0.3573 0.3562 0.3603 0.3616	23 CIE Y 0.3632 0.3562 0.3592 0.3663	CIE X 0.3616 0.3603 0.3645 0.3659	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687 0.3703	43 CIE Y 0.3694 0.3622 0.3652 0.3726
D' CIE X 0.3530 0.3520 0.3562 0.3573 D'	I3 CIE Y 0.3601 0.3533 0.3562 0.3632 I4	CIE X 0.3573 0.3562 0.3603 0.3616 D	23 CIE Y 0.3632 0.3562 0.3592 0.3663 24	CIE X 0.3616 0.3603 0.3645 0.3659 D3	Image: 33 CIE Y 0.3663 0.3592 0.3622 0.3624 0.3694 34	CIE X 0.3659 0.3645 0.3687 0.3703	43 CIE Y 0.3694 0.3622 0.3652 0.3726 44
CIE X 0.3530 0.3520 0.3562 0.3573 D' CIE X	I3 CIE Y 0.3601 0.3533 0.3562 0.3632 I4 CIE Y	CIE X 0.3573 0.3562 0.3603 0.3616 D2 CIE X	23 CIE Y 0.3632 0.3562 0.3592 0.3663 24 CIE Y	CIE X 0.3616 0.3603 0.3645 0.3659 D3 CIE X	CIE Y 0.3663 0.3592 0.3694 0.3694 0.3694 CIE Y	CIE X 0.3659 0.3645 0.3687 0.3703 D4 CIE X	43 CIE Y 0.3694 0.3622 0.3652 0.3726 44 CIE Y
CIE X 0.3530 0.3520 0.3562 0.3573 D' CIE X 0.3520	13 CIE Y 0.3601 0.3533 0.3562 0.3632 14 CIE Y 0.3533	CIE X 0.3573 0.3562 0.3603 0.3616 D CIE X 0.3562	23 CIE Y 0.3632 0.3562 0.3592 0.3663 24 CIE Y 0.3562	CIE X 0.3616 0.3603 0.3645 0.3659 CIE X 0.3603	33 CIE Y 0.3663 0.3592 0.3622 0.3694 64 CIE Y 0.3592	CIE X 0.3659 0.3645 0.3687 0.3703 CIE X 0.3645	43 CIE Y 0.3694 0.3622 0.3652 0.3726 44 CIE Y 0.3622



Color Bin Structure

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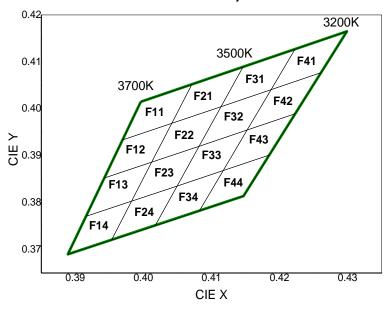
CIE Chromaticity Diagram (Neutral white), $T_j=25^{\circ}C$, $I_F=32mA$

-		-		-		_	
E1	11	E	21	E3	-	E	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3736	0.3874	0.3804	0.3917	0.3871	0.3959	0.3939	0.4002
0.3720	0.3800	0.3784	0.3841	0.3849	0.3881	0.3914	0.3922
0.3784	0.3841	0.3849	0.3881	0.3914	0.3922	0.3979	0.3962
0.3804	0.3917	0.3871	0.3959	0.3939	0.4002	0.4006	0.4044
E1	12	E	22	E	32	E	1 2
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3720	0.3800	0.3784	0.3841	0.3849	0.3881	0.3914	0.3922
0.3703	0.3726	0.3765	0.3765	0.3828	0.3803	0.3890	0.3842
0.3765	0.3765	0.3828	0.3803	0.3890	0.3842	0.3952	0.3880
0.3784	0.3841	0.3849	0.3881	0.3914	0.3922	0.3979	0.3962
0.3784 E1		0.3849 Ež		0.3914 E3		0.3979 E4	
E1	13	E	23	E	33	E	13
E1 CIE X	I3 CIE Y	E: CIE X	23 CIE Y	E3 CIE X	CIE Y	E4 CIE X	I3 CIE Y
E1 CIE X 0.3703	13 CIE Y 0.3726	CIE X 0.3765	23 CIE Y 0.3765	CIE X 0.3828	CIE Y 0.3803	CIE X 0.3890	13 CIE Y 0.3842
E1 CIE X 0.3703 0.3687	CIE Y 0.3726 0.3652	CIE X 0.3765 0.3746	23 CIE Y 0.3765 0.3689	E: CIE X 0.3828 0.3806	CIE Y 0.3803 0.3725	CIE X 0.3890 0.3865	13 CIE Y 0.3842 0.3762
E1 CIE X 0.3703 0.3687 0.3746	3 CIE Y 0.3726 0.3652 0.3689 0.3765	CIE X 0.3765 0.3746 0.3806	CIE Y 0.3765 0.3689 0.3725 0.3803	CIE X 0.3828 0.3806 0.3865	CIE Y 0.3803 0.3725 0.3762 0.3842	CIE X 0.3890 0.3865 0.3925	I3 CIE Y 0.3842 0.3762 0.3798 0.3880
E1 CIE X 0.3703 0.3687 0.3746 0.3765	3 CIE Y 0.3726 0.3652 0.3689 0.3765	CIE X 0.3765 0.3746 0.3806 0.3828	CIE Y 0.3765 0.3689 0.3725 0.3803	CIE X 0.3828 0.3806 0.3865 0.3890	CIE Y 0.3803 0.3725 0.3762 0.3842	CIE X 0.3890 0.3865 0.3925 0.3952	I3 CIE Y 0.3842 0.3762 0.3798 0.3880
E1 CIE X 0.3703 0.3687 0.3746 0.3765 E1	I3 CIE Y 0.3726 0.3652 0.3689 0.3765 I4	CIE X 0.3765 0.3746 0.3806 0.3828	23 CIE Y 0.3765 0.3689 0.3725 0.3803 24	CIE X 0.3828 0.3806 0.3865 0.3890 E3	33 CIE Y 0.3803 0.3725 0.3762 0.3842 34	CIE X 0.3890 0.3865 0.3925 0.3952 E4	I3 CIE Y 0.3842 0.3762 0.3798 0.3880 0.3880 14
E1 CIE X 0.3703 0.3687 0.3746 0.3765 E1 CIE X	I3 CIE Y 0.3726 0.3652 0.3689 0.3765 I4 CIE Y	CIE X 0.3765 0.3746 0.3806 0.3828 CIE X	23 CIE Y 0.3765 0.3689 0.3725 0.3803 24 CIE Y	CIE X 0.3828 0.3806 0.3865 0.3890 CIE X	CIE Y 0.3803 0.3725 0.3762 0.3842 0.3842 0.3842 CIE Y	CIE X 0.3890 0.3865 0.3925 0.3952 CIE X	I3 CIE Y 0.3842 0.3762 0.3798 0.3880 0.3880 CIE Y
CIE X 0.3703 0.3687 0.3746 0.3765 E1 CIE X 0.3687	3 CIE Y 0.3726 0.3652 0.3689 0.3765 14 CIE Y 0.3652	CIE X 0.3765 0.3746 0.3806 0.3828 CIE X 0.3746	23 CIE Y 0.3765 0.3689 0.3725 0.3803 24 CIE Y 0.3689	CIE X 0.3828 0.3806 0.3865 0.3890 CIE X 0.3806	33 CIE Y 0.3803 0.3725 0.3762 0.3842 0.3842 0.3842 CIE Y 0.3725	CIE X 0.3890 0.3865 0.3925 0.3952 CIE X 0.3865	 CIE Y 0.3842 0.3762 0.3798 0.3880 CIE Y 0.3762



Color Bin Structure

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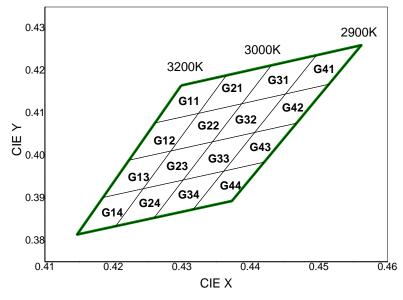
CIE Chromaticity Diagram (Warm white), $T_1=25^{\circ}C$, $I_F=32mA$

F1	1	F2	21	F3	1	F4	11
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3996	0.4015	0.4071	0.4052	0.4146	0.4089	0.4223	0.4127
0.3969	0.3934	0.4042	0.3969	0.4114	0.4005	0.4187	0.4041
0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	0.4261	0.4077
0.4071	0.4052	0.4146	0.4089	0.4223	0.4127	0.4299	0.4165
F1	2	Fź	22	F3	2	F4	12
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3969	0.3934	0.4042	0.3969	0.4114	0.4005	0.4187	0.4041
0.3943	0.3853	0.4012	0.3886	0.4082	0.3920	0.4152	0.3955
0.4012	0.3886	0.4082	0.3920	0.4152	0.3955	0.4223	0.3990
0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	0.4261	0.4077
F1	3	F	23	F3	3	F4	13
F1 CIE X	3 CIE Y	F2 CIE X	23 CIE Y	F3 CIE X	CIE Y	F4 CIE X	I3 CIE Y
		_					
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3943	CIE Y 0.3853	CIE X 0.4012	CIE Y 0.3886	CIE X 0.4082	CIE Y 0.3920	CIE X 0.4152	CIE Y 0.3955
CIE X 0.3943 0.3916	CIE Y 0.3853 0.3771	CIE X 0.4012 0.3983	CIE Y 0.3886 0.3803	CIE X 0.4082 0.4049	CIE Y 0.3920 0.3836	CIE X 0.4152 0.4117	CIE Y 0.3955 0.3869
CIE X 0.3943 0.3916 0.3983	CIE Y 0.3853 0.3771 0.3803 0.3886	CIE X 0.4012 0.3983 0.4049 0.4082	CIE Y 0.3886 0.3803 0.3836	CIE X 0.4082 0.4049 0.4117	CIE Y 0.3920 0.3836 0.3869 0.3955	CIE X 0.4152 0.4117 0.4185	CIE Y 0.3955 0.3869 0.3902 0.3990
CIE X 0.3943 0.3916 0.3983 0.4012	CIE Y 0.3853 0.3771 0.3803 0.3886	CIE X 0.4012 0.3983 0.4049 0.4082	CIE Y 0.3886 0.3803 0.3836 0.3920	CIE X 0.4082 0.4049 0.4117 0.4152	CIE Y 0.3920 0.3836 0.3869 0.3955	CIE X 0.4152 0.4117 0.4185 0.4223	CIE Y 0.3955 0.3869 0.3902 0.3990
CIE X 0.3943 0.3916 0.3983 0.4012 F1	CIE Y 0.3853 0.3771 0.3803 0.3886 4	CIE X 0.4012 0.3983 0.4049 0.4082	CIE Y 0.3886 0.3803 0.3836 0.3920 24	CIE X 0.4082 0.4049 0.4117 0.4152 F3	CIE Y 0.3920 0.3836 0.3869 0.3955 4	CIE X 0.4152 0.4117 0.4185 0.4223 F ²	CIE Y 0.3955 0.3869 0.3902 0.3990 14
CIE X 0.3943 0.3916 0.3983 0.4012 F1 CIE X	CIE Y 0.3853 0.3771 0.3803 0.3886 4 CIE Y	CIE X 0.4012 0.3983 0.4049 0.4082 F2 CIE X	CIE Y 0.3886 0.3803 0.3836 0.3920 24 CIE Y	CIE X 0.4082 0.4049 0.4117 0.4152 F3 CIE X	CIE Y 0.3920 0.3836 0.3869 0.3955 4 CIE Y	CIE X 0.4152 0.4117 0.4185 0.4223 F ² CIE X	CIE Y 0.3955 0.3869 0.3902 0.3990 14 CIE Y
CIE X 0.3943 0.3916 0.3983 0.4012 F1 CIE X 0.3916	CIE Y 0.3853 0.3771 0.3803 0.3886 4 CIE Y 0.3771	CIE X 0.4012 0.3983 0.4049 0.4082 F2 CIE X 0.3983	CIE Y 0.3886 0.3803 0.3836 0.3920 24 CIE Y 0.3803	CIE X 0.4082 0.4049 0.4117 0.4152 F3 CIE X 0.4049	CIE Y 0.3920 0.3836 0.3869 0.3955 4 CIE Y 0.3836	CIE X 0.4152 0.4117 0.4185 0.4223 F ² CIE X 0.4117	CIE Y 0.3955 0.3869 0.3902 0.3990 44 CIE Y 0.3869



Color Bin Structure

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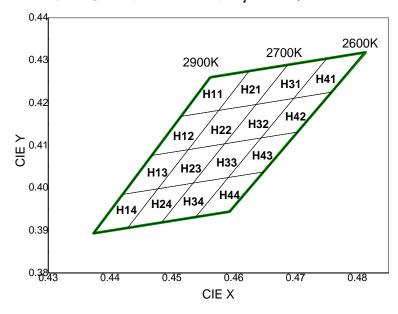
G41 G11 G21 G31 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4299 0.4165 0.4364 0.4188 0.4430 0.4212 0.4496 0.4236 0.4077 0.4145 0.4261 0.4324 0.4099 0.4387 0.4122 0.4451 0.4324 0.4100 0.4387 0.4122 0.4451 0.4145 0.4514 0.4168 0.4365 0.4189 0.4430 0.4212 0.4496 0.4236 0.4562 0.4260 G12 G22 G32 G42 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4077 0.4324 0.4100 0.4122 0.4451 0.4145 0.4261 0.4387 0.4033 0.4223 0.3990 0.4284 0.4011 0.4345 0.4406 0.4055 0.4284 0.4011 0.4345 0.4033 0.4406 0.4055 0.4468 0.4077 0.4324 0.4100 0.4387 0.4122 0.4451 0.4145 0.4515 0.4168 G13 G23 G33 G43 CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE X CIE Y 0.4223 0.4284 0.4011 0.4033 0.3990 0.4345 0.4406 0.4055 0.4185 0.3902 0.4243 0.3922 0.4302 0.3943 0.4361 0.3964 0.4243 0.3922 0.4302 0.3943 0.4361 0.3964 0.4420 0.3985 0.4284 0.4011 0.4345 0.4033 0.4406 0.4055 0.4468 0.4077 G14 G24 G34 G44 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4243 0.3922 0.4302 0.3943 0.4302 0.3943 0.4361 0.3964 0.4203 0.3834 0.4259 0.3853 0.4259 0.3853 0.4316 0.3873 0.4147 0.3814 0.4203 0.3834 0.4316 0.3873 0.4373 0.3893 0.4185 0.3902 0.4243 0.3922 0.4361 0.3964 0.4420 0.3985

CIE Chromaticity Diagram (Warm white), $T_j=25^{\circ}C$, $I_F=32mA$



Color Bin Structure

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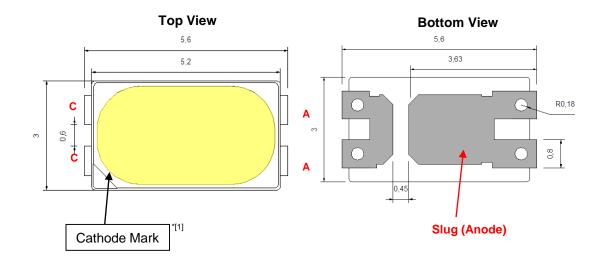
H41 H11 H21 H31 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4562 0.4260 0.4625 0.4275 0.4687 0.4289 0.4750 0.4304 0.4515 0.4168 0.4575 0.4182 0.4636 0.4197 0.4697 0.4211 0.4575 0.4182 0.4636 0.4197 0.4697 0.4211 0.4758 0.4225 0.4625 0.4275 0.4687 0.4289 0.4750 0.4304 0.4810 0.4319 H12 H22 H32 H42 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4515 0.4168 0.4575 0.4182 0.4636 0.4197 0.4697 0.4211 0.4077 0.4526 0.4468 0.4090 0.4585 0.4104 0.4644 0.4118 0.4526 0.4090 0.4585 0.4104 0.4644 0.4118 0.4703 0.4132 0.4575 0.4182 0.4636 0.4197 0.4697 0.4211 0.4758 0.4225 H13 H23 H33 H43 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4526 0.4468 0.4077 0.4090 0.4585 0.4104 0.4644 0.4118 0.4420 0.3985 0.4477 0.3998 0.4534 0.4012 0.4591 0.4025 0.4477 0.4534 0.4591 0.3998 0.4012 0.4025 0.4648 0.4038 0.4526 0.4090 0.4585 0.4104 0.4644 0.4118 0.4703 0.4132 H14 H24 H34 H44 CIE X CIE Y CIE X CIE Y CIE X CIE Y CIE X CIE Y 0.4420 0.3985 0.4477 0.3998 0.4534 0.4012 0.4591 0.4025 0.4373 0.3893 0.4428 0.3906 0.4483 0.3919 0.4538 0.3932 0.4428 0.3906 0.4483 0.3919 0.4538 0.3932 0.4593 0.3944 0.4477 0.3998 0.4534 0.4012 0.4591 0.4025 0.4648 0.4038

CIE Chromaticity Diagram (Warm white), T_i=25°C, I_F=32mA



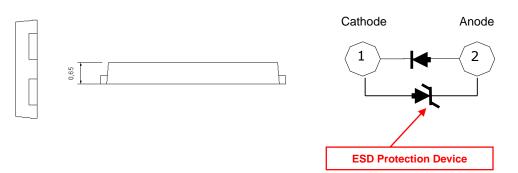
Mechanical Dimensions

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Side View





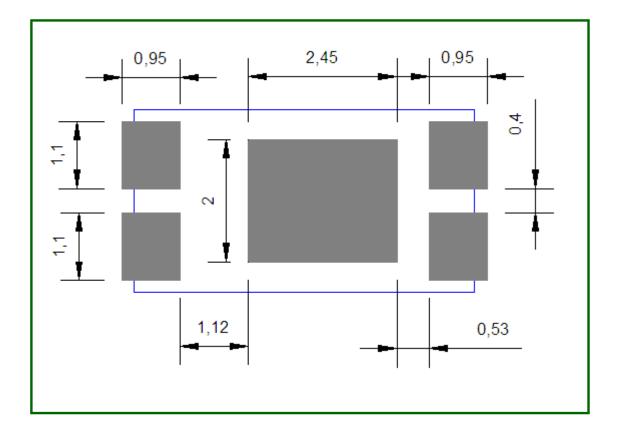
Notes :

- (1) All dimensions are in millimeters.
- (2) Scale : none
- (3) Undefined tolerance is $\pm 0.2 \text{mm}$



SAW7Q24D – Mid-Power LED

Recommended Solder Pad



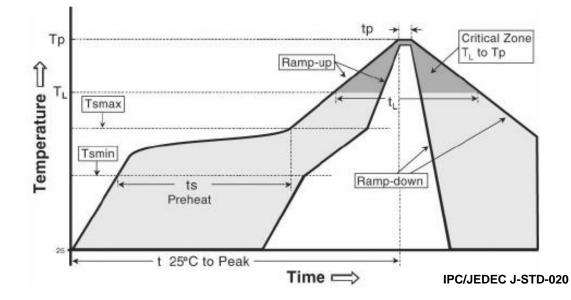
Notes :

- (1) All dimensions are in millimeters.
- (2) Scale : none
- (3) This drawing without tolerances are for reference only
- (4) Undefined tolerance is $\pm 0.1 \text{mm}$
- (5) The appearance and specifications of the product may be changed for improvement without notice.

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SAW7Q24D – Mid-Power LED

Reflow Soldering Characteristics



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate $(T_{s_max} \text{ to } T_p)$	3° C/second max.	3° C/second max.
Preheat - Temperature Min (T _{s_min}) - Temperature Max (T _{s_max}) - Time (T _{s_min} to T _{s_max}) (t _s)	100 °C 150 °C 60-120 seconds	150 ℃ 200 ℃ 60-180 seconds
Time maintained above: - Temperature (T _L) - Time (t _L)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (T _p)	215℃	260°C
Time within 5°C of actual Peak Temperature (t _p)2	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

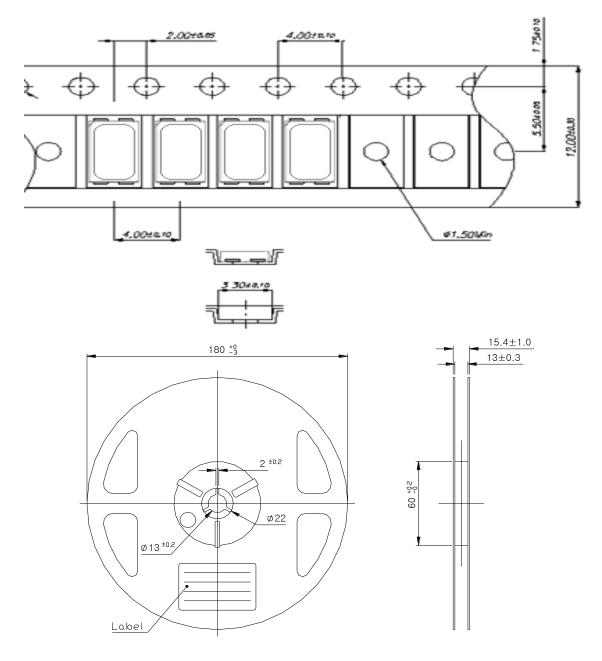
Caution :

- Reflow soldering is recommended not to be done more than two times In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.



SAW7Q24D - Mid-Power LED

Emitter Tape & Reel Packaging



(Tolerance: $\pm 0.2, \ \text{Unit: mm}$)

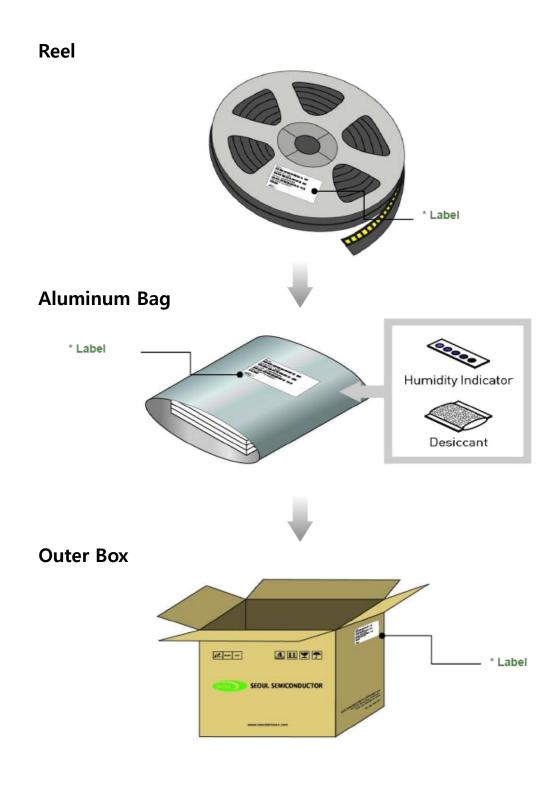
Notes :

- (1) Quantity : Max 4,500pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be \pm 0.2mm
- (3) Adhesion Strength of Cover Tape
- Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape.
- (4) Package : P/N, Manufacturing data Code No. and Quantity to be indicated on a damp proof Package.





Emitter Tape & Reel Packaging



Product Nomenclature

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Table 7. Part Numbering System : X₁X₂X₃X₄X₅X₆X₇X₈

Part Number Code	Description	Part Number	Value
X ₁	Company	S	SSC
X ₂	Top View LED series	А	Acrich
X ₃	Color Specification	W7	CRI 70
X4	Package series	Q	5630 Series
X ₅ X ₆	Characteristic code	24	
X ₇	Revision	D	

Table 8. Lot Numbering System $:Y_1Y_2Y_3Y_4Y_5Y_6Y_7Y_8Y_9Y_{10}-Y_{11}Y_{12}Y_{13}Y_{14}Y_{15}Y_{16}Y_{17}$

Lot Number Code	Description	Lot Number	Value
Y ₁ Y ₂	Year		
Y ₃	Month		
Y ₄ Y ₅	Day		
Y ₆	Top View LED series		
Y ₇ Y ₈ Y ₉ Y ₁₀	Mass order		
Y ₁₁ Y ₁₂ Y ₁₃ Y ₁₄ Y ₁₅ Y ₁₆ Y ₁₇	Internal Number		

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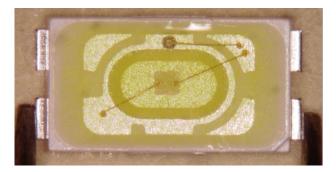


Handling of Silicone Resin for LEDs

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



(2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.



(3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.

(4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust.

As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.

(5) SSC suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.

(6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this. product with acid or sulfur material in sealed space.

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SAW7Q24D – Mid-Power LED

Precaution for Use

(1) Storage

To avoid the moisture penetration, we recommend store in a dry box with a desiccant. The recommended storage temperature range is 5° C to 30° C and a maximum humidity of RH50%.

(2) Use Precaution after Opening the Packaging

Use proper SMT techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency.

Pay attention to the following:

- a. Recommend conditions after opening the package
 - Sealing
 - Temperature : 5 ~ 30°C Humidity : less than RH60%
- b. If the package has been opened more than 4 week(MSL_2a) or the color of the desiccant changes, components should be dried for 10-24hr at 65±5℃
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- (4) Do not rapidly cool device after soldering.
- (5) Components should not be mounted on warped (non coplanar) portion of PCB.
- (6) Radioactive exposure is not considered for the products listed here in.
- (7) Gallium arsenide is used in some of the products listed in this publication.These products are dangerous if they are burned or shredded in the process of disposal.It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.
- (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- (9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.

Precaution for Use

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- (10) The appearance and specifications of the product may be modified for improvement without notice.
- (11) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- (12) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.
- (13) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (14) The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.
- (15) Similar to most Solid state devices;

LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.

a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event. One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic wrist-strap
- Antistatic material shoes
- Antistatic clothes

Environmental controls:

- Humidity control (ESD gets worse in a dry environment)



Precaution for Use

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package

(If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)

- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures. It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred:

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package
- (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
- This damage usually appears due to the thermal stress produced during the EOS event.

c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:

- A surge protection circuit
- An appropriately rated over voltage protection device
- A current limiting device



Company Information

Published by

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Company Information

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

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